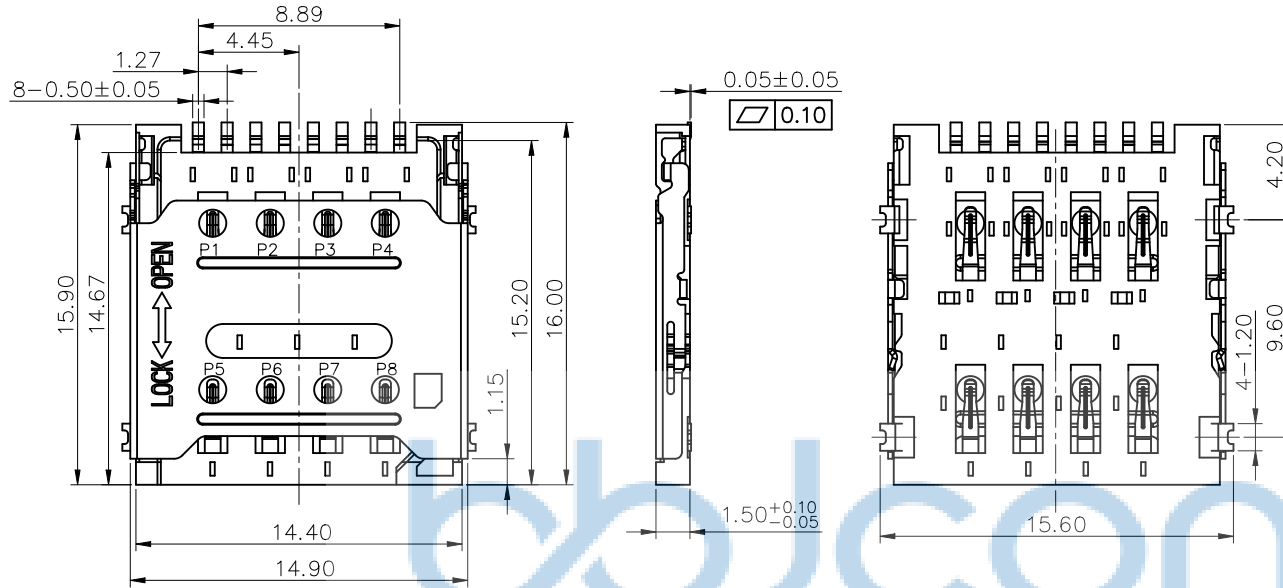
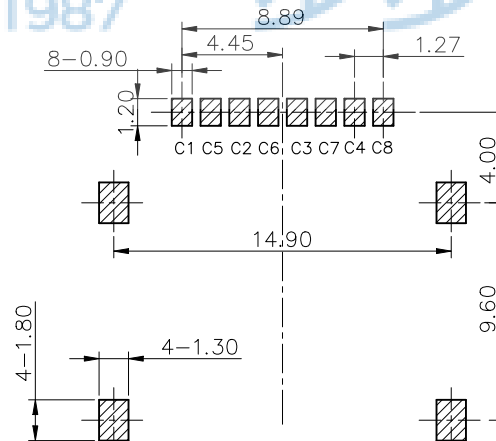
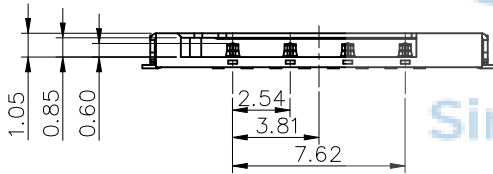




NOTES:

- MATERIAL:
 - Housing: High Temperature Thermoplastic UL94V-0; Color Black.
 - Terminal/Nail: Copper Alloy.
 - Shell: Stainless Steel
- FINISH:
 - Terminal: Plated Gold on the Contact Area and Solder Tails, Underplated Nickel Over all.
 - Nail: Plated Gold on the Solder Tails, Underplated Nickel Over all.
- SPECIALITY:
 - Rated current: 1.0A
 - Rated voltage: 30V
 - Contact Resistance: 50mΩ MAX
 - Insulation Resistance: 100MΩ MIN 100V DC
 - Dielectric withstanding voltage: 250V AC.
 - Solder ability: 245±5°C, 5±0.5s.
 - Durability: 5000 Cycles Min.
 - Operating condition:
 - Operating Temperature: -30°C~+85°C
 - Humidity: 80% R.H MAX



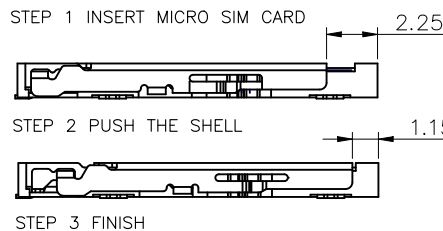
RECOMMENDED PCB LAYOUT

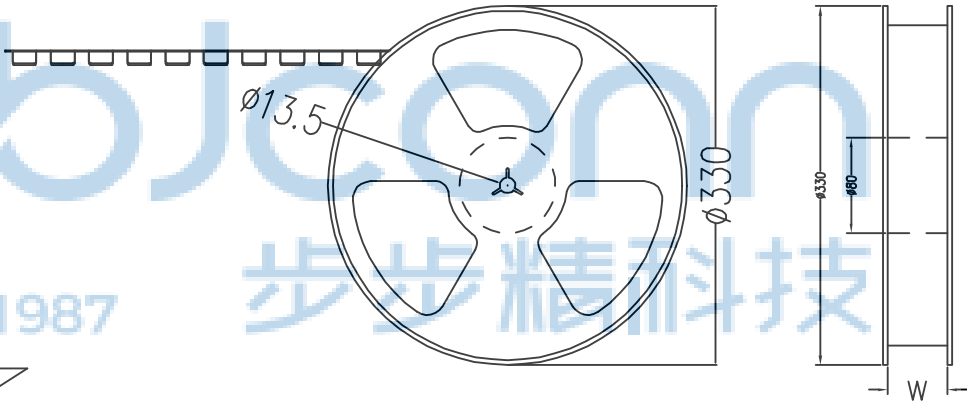
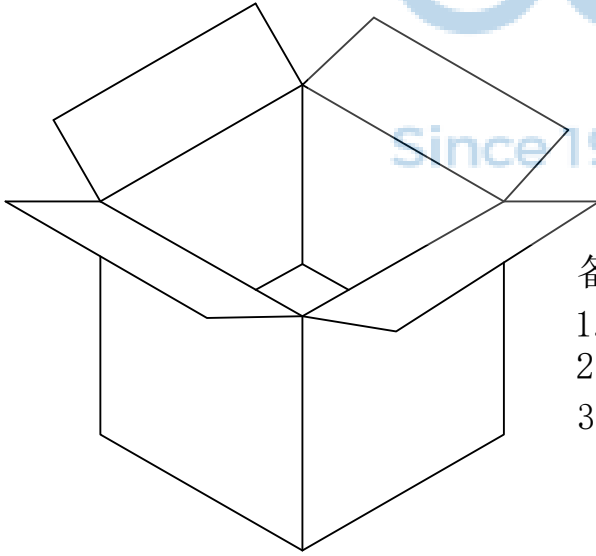
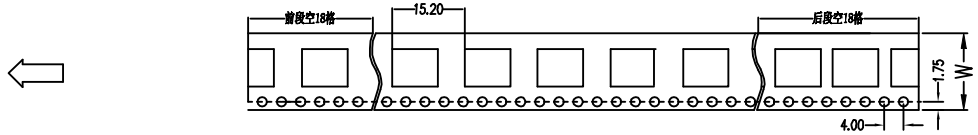
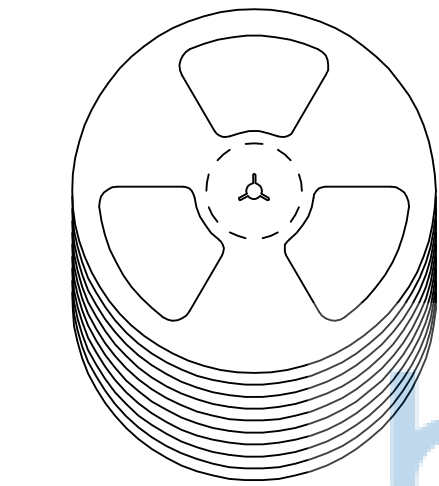
TOLERANCE: ±0.05
THERE SHOULD NOT BE ANY CIRCUITRIES IN THE LAYOUT SPACE OF THE PRODUCT.



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PDWG.NO: 0390-1

深圳市步步精科技有限公司		NAME: 卡座 MICRO SIM 8P H=1.5 贴片大掀盖 编带	
.X: ±0.38 .XX: ±0.25 .XXX: ±0.13	X': ±3' .X': ±2' .XX': ±1'	APPD. JM_Zheng	PJ. NO.: 142-202-080002-S4G
CHKD. LYX		DR. SGF	SIZE: A4 DRW NO.: CS-234-08W
			FINISH: SEE NOTES MAT'L: SEE NOTES
			SCALE: N/A REV.: A0 UNIT: mm PAGE: 1/2





备注：
1. 包装数量：1400/PCS/卷，10卷/箱。
2. 包装袋长度：每卷前后各空10-20个空格，中间包装。
3. 材质：
 载体：聚丙烯（PS），阻抗 $10^{6-9} \Omega$
 上带：聚乙烯（PET），阻抗 $10^{6-11} \Omega$
 卷盘：聚苯乙烯。

纸箱规格：345*345*230MM
纸箱规格：345*345*350MM

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PDWG.NO:	0390-1	SIZE: A4 DRW NO.: CS-234-08W	
DR.		FINISH: SEE NOTES MAT'L.: SEE NOTES	
		SCALE: N/A REV.: A0 UNIT: mm PAGE: 2/2	